

特性/机械性能:

FEATURES/MECHANICAL DATA

- ◆UL Recognized File # E-230084
- ◆Ideal for printed circuit board
- ◆Reliable low cost construction technique results in inexpensive product
- ◆High temperature soldering guaranteed:
260°C / 10 seconds
lead length at 5 lbs., (2.3 kg) tension
- ◆Case: Molded plastic
- ◆Lead: solder plated
- ◆Polarity: As marked



最大额定值及电气特性

MAXIMUM RATINGS AND CHARACTERISTICS

测量环境温度为25°C, 除非另有规定. 单相半波, 50HZ, 阻性或感性负载, 对于容性负载, 电流降额20%。
Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 50HZ, resistive or inductive load. For capacitive load, derate current by 20%.

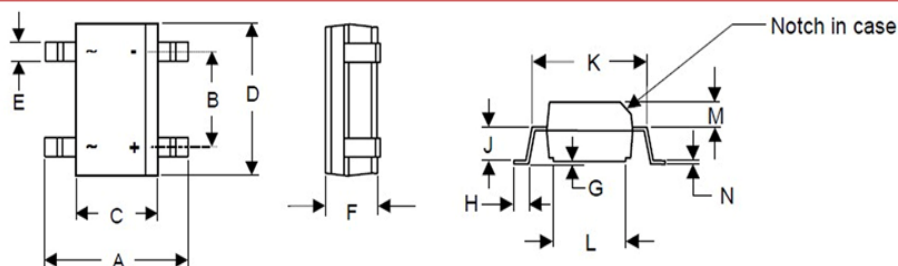
Papt Number	Symbol	MB2S	MB4S	MB6S	MB8S	MB10S	Unit
		YJ2J	YJ4J	YJ6J	YJ8J	YJ10J	
Maximum Repetitive Peak Reverse Voltage	VRRM	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	140	280	420	560	700	V
Maximum DC blocking Voltage	VDC	200	400	600	800	1000	V
Maximum Average Forward Rectified Current On glass-epoxy P.C.B.	I(AV)	0.5					A
On aluminum substrate		0.8					A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	IFSM	35					A
Maximum Instantaneous Forward Voltage@ 0.4A	VF	1.0					V
Maximum DC Reverse Current @ TA=25℃	IR	5.0					μA
rated DC blocking voltage per leg TA = 125℃		500					μA
Typical Thermal Resistance (Note1)	RθJA	70					℃/W
(Note2)	RθJL	20					
Operating Temperature Range	TJ	-55 to +150					℃
Storage Temperature Range	TSTG	-55 to +150					℃

NOTE:

- 1.On aluminum suvstrate P.C.B. with an area of 0.8×0.8"(20×20mm) mounted on 0.05×0.05"(1.3×1.3mm) solder pad.
- 2.On glass epoxy P.C.B. mouted on 0.05×0.05"(1.3×1.3mm) pads.

产品外形尺寸:

Product appearance size



DIM	INC HES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	.252	.272	6.40	6.91	
B	.095	.105	2.41	2.67	
C	.145	.155	3.68	3.94	
D	.180	.190	4.57	4.83	
E	.017	.029	0.45	0.75	
F	.090	.106	2.30	2.70	
G	.004	.008	0.10	0.20	
H	.021	.023	0.53	0.58	
J	.055	.065	1.40	1.65	
K	-----	.200	-----	5.08	
L	.107	.117	2.72	2.97	
M	.040	.050	1.02	1.27	
N	.008	.014	0.15	0.35	

特性曲线图:

RATINGS AND CHARACTERISTIC CURVES

FIG.1-MAXIMUM NONO-REPETITIVE FORWARD SURGE CURRENT PER BRIDGE ELELMENT

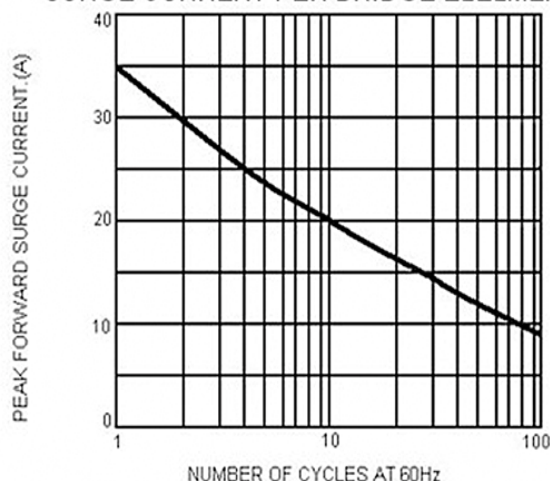


FIG.2-MAXIMUM FORWARD CURRENT DERATING CURVE

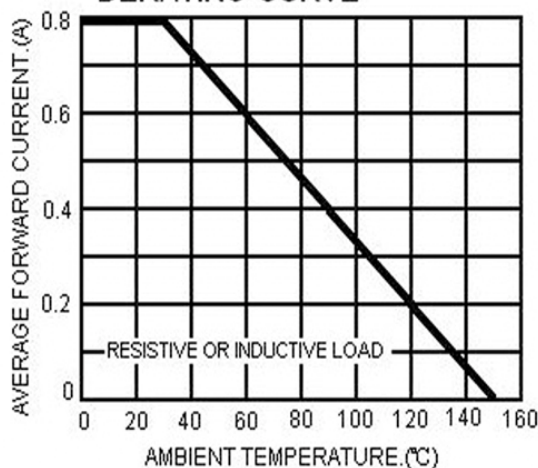


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS PER BRIDGE ELEMENT

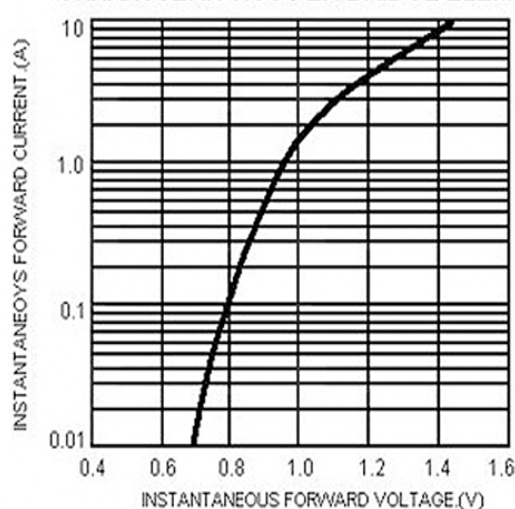


FIG.4-TYPICAL REVERSE CHARACTERISTICS PER BRIDGE ELEMENT

